

5N70Z

Power MOSFET

5A, 700V LOGIC
N-CHANNEL MOSFET

■ DESCRIPTION

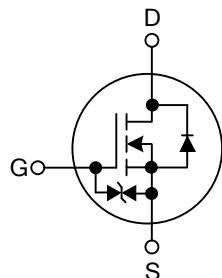
The UTC **5N70Z** is an N-Ch annel enhancement MOSFET, it uses UT C's advanced technology to provide customers with a minimum on-state resistance, high switching speed and low gate charge. It can also withstand high energy pulse in the avalanche and commutation modes.

The UTC **5N70Z** is suitable for high efficiency switching DC/DC converter, motor control and switch mode power supply.

■ FEATURES

- * $R_{DS(ON)} < 2.5\Omega$ @ $V_{GS} = 10V$
- * Low gate charge (Typ=4.8nC)
- * Low C_{RSS} (Typ=6.0pF)
- * High switching speed
- * ESD Capability

■ SYMBOL



■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
5N70ZL-TF3-T 5N70Z	G-TF3-T	TO-220F	G	D	S	Tube
5N70ZL-TF1-T 5N70Z	G-TF1-T	TO-220F1	G	D	S	Tube
5N70ZL-TF2-T 5N70Z	G-TF2-T	TO-220F2	G	D	S	Tube
5N70ZL-TM3-T 5N70Z	G-TM3-T	TO-251	G	D	S	Tube
5N70ZL-TN3-R 5N70Z	G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

5N70ZL-TF3-T 	(1)T: Tube, R: Tape Reel (2)TF3: TO-220F, TF1: TO-220F1, TF2: TO-220F2 TM3: TO-251, TN3: TO-252 (3)L: Lead Free, G: Halogen Free
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■ MARKING INFORMATION

PACKAGE	MARKING
TO-220F	
TO-220F1	
TO-220F2	
TO-251	
TO-252	<p>The marking diagram for the TO-252 package shows the following layout: 'UTC' at the top, '5N70Z' in the center, and a row of six squares below it. Arrows point from specific parts of the marking to labels: 'Lot Code' points to the first square, '1' points to the second square, 'L: Lead Free' points to the third square, 'G: Halogen Free' points to the fourth square, and 'Data Code' points to the fifth square.</p>

■ ABSOLUTE MAXIMUM RATINGS ($T_C=25^\circ\text{C}$, unless otherwise noted)

PARAMETER SYMBOL		RATINGS	UNIT
Drain-Source Voltage	V_{DSS}	700	V
Gate-Source Voltage	V_{GSS}	± 20	V
Avalanche Current (Note 2)	I_{AR}	5	A
Drain Current	Continuous I_D	5	A
	Pulsed (Note 2)	I_{DM} 20	A
Avalanche Energy	Single Pulsed (Note 3)	E_{AS} 100	mJ
	Repetitive (Note 2)	E_{AR} 10	mJ
Peak Diode Recovery dv/dt (Note 4)	dv/dt	4.5	V/ns
Power Dissipation	TO-220F/TO-220F1	P_D	36 W
	TO-220F2		28
	TO-251/TO-252		W
Junction Temperature	T_J	+150	$^\circ\text{C}$
Operation Temperature	T_{OPR}	-55~+150	$^\circ\text{C}$
Storage Temperature	T_{STG}	-55~+150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. $L=6.2\text{mH}$, $I_{AS}=5\text{A}$, $V_{DD}=50\text{V}$, $R_G=25\Omega$, Starting $T_J=25^\circ\text{C}$.

4. $I_{SD}\leq 4.5\text{A}$, $di/dt\leq 300\text{A}/\mu\text{s}$, $V_{DD}\leq BV_{DSS}$, Starting $T_J=25^\circ\text{C}$

■ THERMAL CHARACTERISTICS

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220F/TO-220F1	θ_{JA}	62.5 $^\circ\text{C/W}$	
	TO-220F2		110	$^\circ\text{C/W}$
Junction to Case	TO-251/TO-252	θ_{JC}	3.47 $^\circ\text{C/W}$	
	TO-220F/TO-220F1		4.53	$^\circ\text{C/W}$
	TO-220F2			

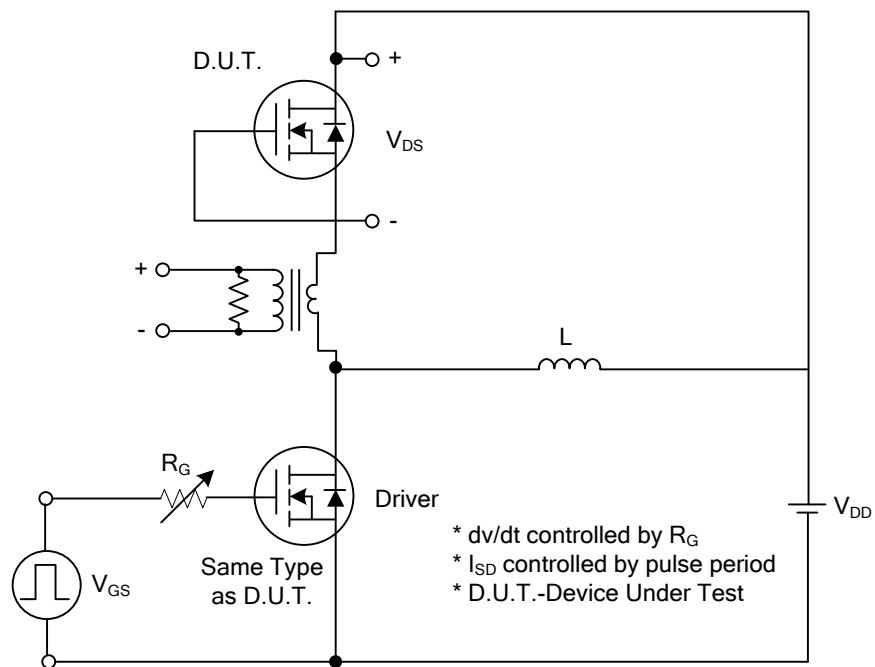
■ ELECTRICAL CHARACTERISTICS ($T_C=25^\circ\text{C}$, unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$	700			V
Breakdown Voltage Temperature Coefficient	$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	Reference to 25°C , $I_D=250\mu\text{A}$		0.18		$\text{V}/^\circ\text{C}$
Drain-Source Leakage Current	$I_{\text{DS}S}$	$V_{DS}=700\text{V}, V_{GS}=0\text{V}$		1		μA
		$V_{DS}=560\text{V}, V_{GS}=0\text{V}, T_C=125^\circ\text{C}$		10		μA
Gate-Source Leakage Current	Forward	$V_{GS}=+20\text{V}, V_{DS}=0\text{V}$		+10		μA
	Reverse \	$V_{GS}=-20\text{V}, V_{DS}=0\text{V}$		-10		μA
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(\text{TH})}$	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	2	4		V
Static Drain-Source On-State Resistance	$R_{DS(\text{ON})}$	$V_{GS}=10\text{V}, I_D=2.5\text{A}$		2.15	2.5	Ω
DYNAMIC PARAMETERS						
Input Capacitance	C_{ISS}	$V_{GS}=0\text{V}, V_{DS}=25\text{V}, f=1.0\text{MHz}$	420	625		pF
Output Capacitance	C_{OSS}		55	65		pF
Reverse Transfer Capacitance	C_{RSS}		9	12		pF
SWITCHING PARAMETERS						
Turn-ON Delay Time	$t_{D(\text{ON})}$	$V_{DD}=30\text{V}, I_D=0.5\text{A}, R_G=25\Omega$ (Note 1, 2)	40	60		ns
Rise Time	t_R		42	60		ns
Turn-OFF Delay Time	$t_{D(\text{OFF})}$		135	155		ns
Fall-Time	t_F		48	60		ns
Total Gate Charge	Q_G	$V_{GS}=5\text{V}, V_{DS}=160\text{V}, I_D=4.5\text{A}$ (Note 1, 2)	70	90		nC
Gate to Source Charge	Q_{GS}		20			nC
Gate to Drain Charge	Q_{GD}		15			nC
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Maximum Body-Diode Continuous Current	I_S			5		A
Maximum Body-Diode Pulsed Current	I_{SM}			20		A
Drain-Source Diode Forward Voltage	V_{SD}	$I_S=5\text{A}, V_{GS}=0\text{V}$		1.4		V
Body Diode Reverse Recovery Time	t_{rr}	$I_S=4.5\text{A}, V_{GS}=0\text{V}, dI_F/dt=100\text{A}/\mu\text{s}$	95			ns
Body Diode Reverse Recovery Charge	Q_{RR}	(Note 1)	0.3			μC

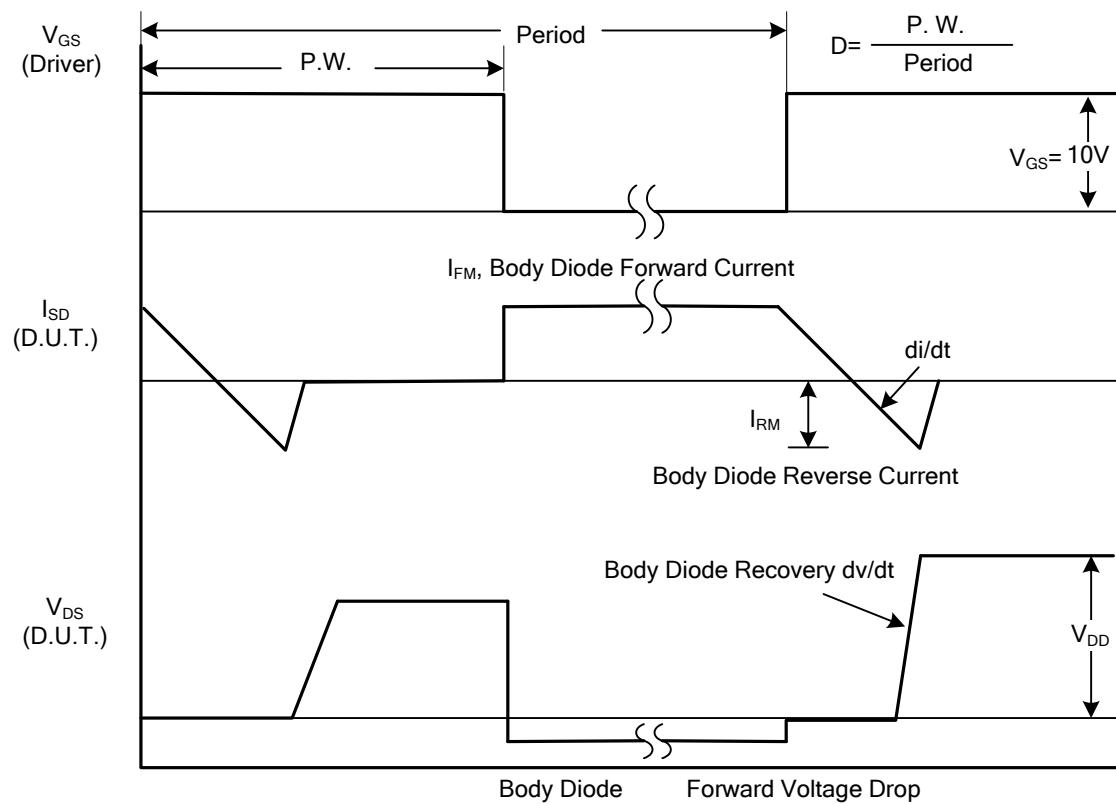
Notes: 1. Pulse Test: Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$

2. Essentially independent of operating temperature

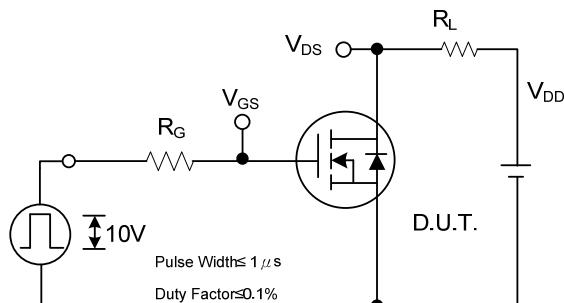
■ TEST CIRCUITS AND WAVEFORMS



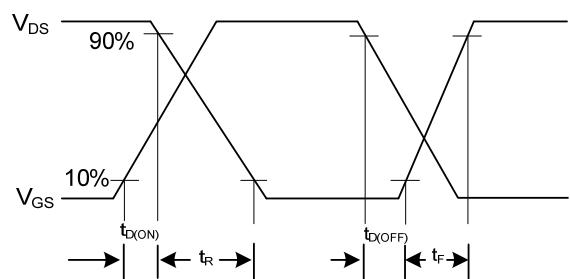
Peak Diode Recovery dv/dt Test Circuit



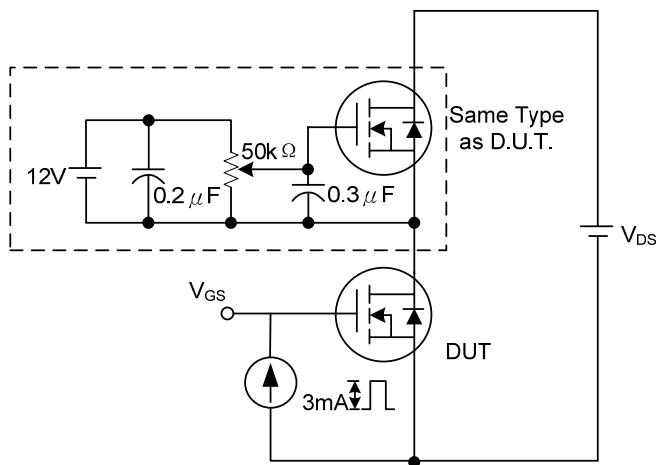
■ TEST CIRCUITS AND WAVEFORMS(Cont.)



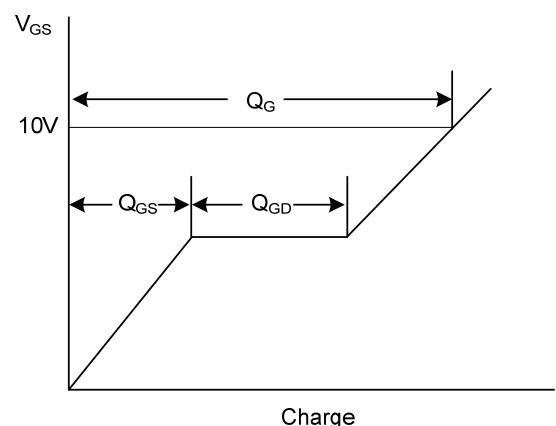
S switching Test Circuit



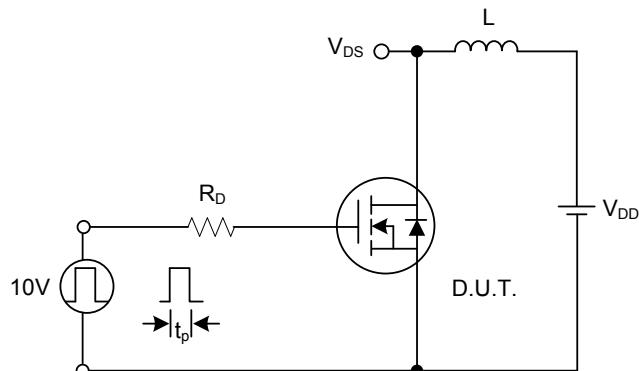
Switching Waveforms



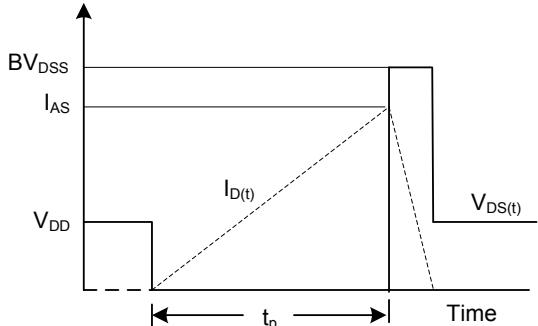
Gate Charge Test Circuit



Gate Charge Waveform

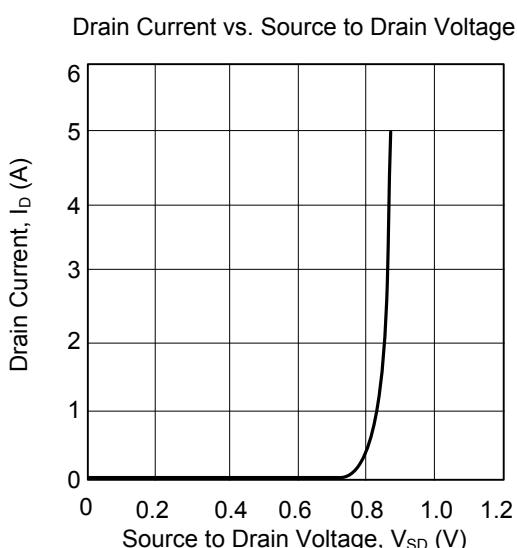
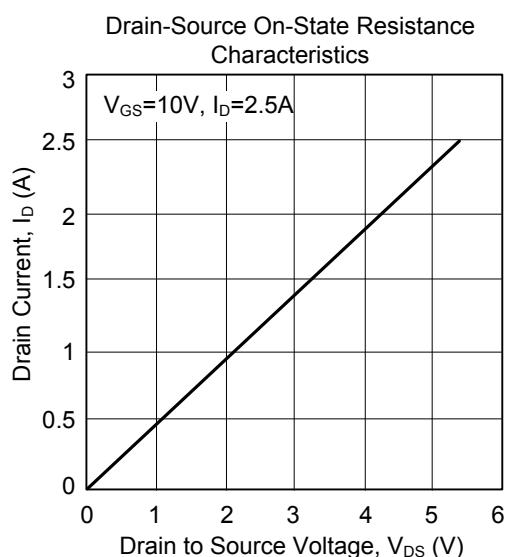
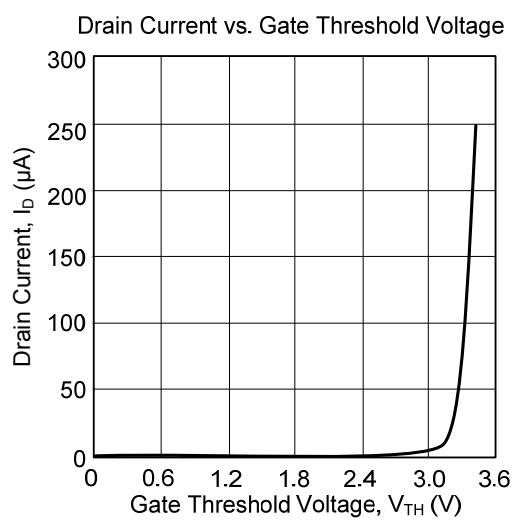
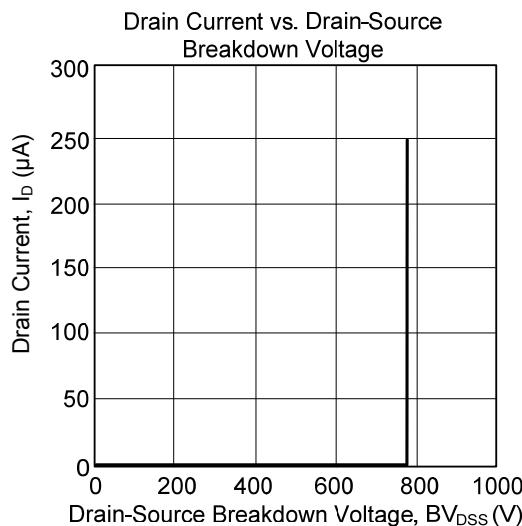


Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS



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